MSKSEMI 美森科













FSD

TV

TSS

MOV

GDT

PIFD

MS2A40LDF

Product specification





FEATURES

- Low Forward Voltage Drop
- Extremely Small DFN1610-2L Package
- Surface Device Type Mounting
- RoHS Compliant
- Green EMC
- Band Indicates Cathode
- Tape and reel: 3,000Pcs/ 7" reel

APPLICATIONS

- Low voltage rectification
- Reverse polarity protection
- Low power consumption applications

Reference News

| PACKAGE OUTLINE | Marking |
|--|---------|
| Richard Control of the Control of th | JU4 |
| DFN1610-2L | |



MAXIMUM RATING (Ta=25℃ unless otherwise noted)

| Symbol | Parameter | Value | Units |
|--------|---|-------------|------------|
| VRRM | Maximum repetitive reverse voltage | 40 | V |
| VR | Maximum DC blocking reverse voltage | 40 | V |
| IF(AV) | Average Forward Current | 2 | А |
| IFSM | Peak Forward Surge Current (At 8.3ms single half sine-wave) | 20 | А |
| TJ | Operating Junction Temperature | -50 to +125 | $^{\circ}$ |
| TSTG | Storage Temperature Range | -50 to +150 | $^{\circ}$ |

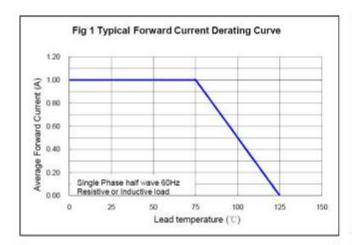
These ratings are limiting values above which the serviceability of the diode may be impaired.

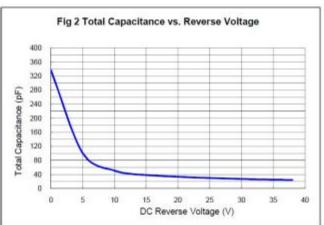
ELECTRICAL CHARACTERISTICS (Ta=25℃)

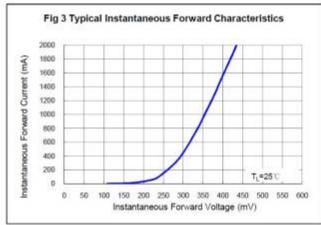
| Parameter | Symbol | Min. | Тур. | Max. | Unit |
|--|--------|------|------|------|------|
| Breakdown Voltage at IR=0.1mA | VBR | 40 | | | V |
| Reverse Leakage Current at VR=40V | lR | | | 80 | μA |
| Forward Voltage at IF=1A | VF | | 0.37 | 0.42 | V |
| Forward Voltage at IF=2A | VF | | | 0.50 | V |
| Junction Capacitance V _R = 0V, f = 1MHz | CJ | | 340 | 400 | pF |

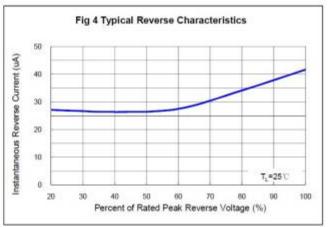


ELECTRICAL CHARACTERISTICS CURVE



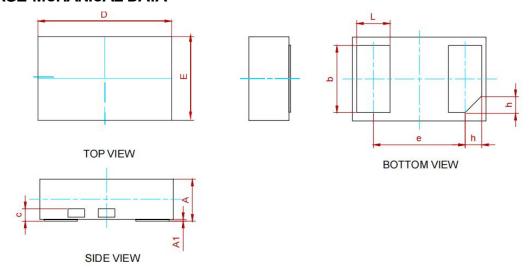






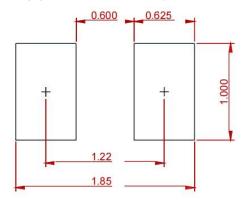


PACKAGE MCHANICAL DATA



| Cumbal | Di | Dimensions in Millimeters | | |
|--------|------|---------------------------|------|--|
| Symbol | Min. | Тур. | Max. | |
| А | 0.45 | 0.50 | 0.55 | |
| A1 | 0.00 | 0.02 | 0.05 | |
| С | | 0. 15 Ref. | | |
| b | 0.75 | 0.80 | 0.85 | |
| L | 0.35 | 0.40 | 0.45 | |
| D | 1.55 | 1.60 | 1.65 | |
| E | 0.95 | 1.00 | 1.05 | |
| е | | 1. 10 BSC | | |
| h | | 0.20 Ref. | | |

Suggested Pad Layout



Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

REEL SPECIFICATION

| P/N | PKG | QTY |
|-----------|-----------|------|
| MS2A40LDF | DFN1610-2 | 3000 |



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